

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Mr. Chih-Liang Fang	05/04/2006
RECEIVING PARTY DATA	
Name:	ADLINK TECHNOLOGY INC.
Street Address:	9F, 9F-1, 9F-2, 9F-3, No. 166, JianYi Rd
City:	Chungho City, Taipei Hsien
State/Country:	TAIWAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	11381536
CORRESPONDENCE DATA	
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NAME OF SUBMITTER:	Chih-Liang Fang
Total Attachments: 2 source=Assignment#page1.tif source=Assignment#page2.tif	

OP \$40.00 11381536

ASSIGNMENT

WHEREAS,

1. **Feng-Qing Su**

2.

Hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: **FASTENER FOR FASTENING A THERMAL MODULE AND A MOTHERBOARD TO METAL FACE PANEL**

[] Filed: Serial No.

[X] Executed concurrently with the execution of this instrument

WHEREAS, **ADLINK TECHNOLOGY INC.**

**9F, 9F-1, 9F-2, 9F-3, No. 166, Jian Yi Road., Chungo City, Taipei,
Taiwan, R.O.C.**

Hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent that may be granted on the same.

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do self, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Fang Chih-Liang

Signature:

04/27/2006

Date:

Sole or First Joint Inventor: Chih-Liang Fang

Signature:

Date:

Second Joint Inventor (if any):

Signature:

Date:

Third Joint Inventor (if any):

Signature:

Date:

Fourth Joint Inventor (if any):